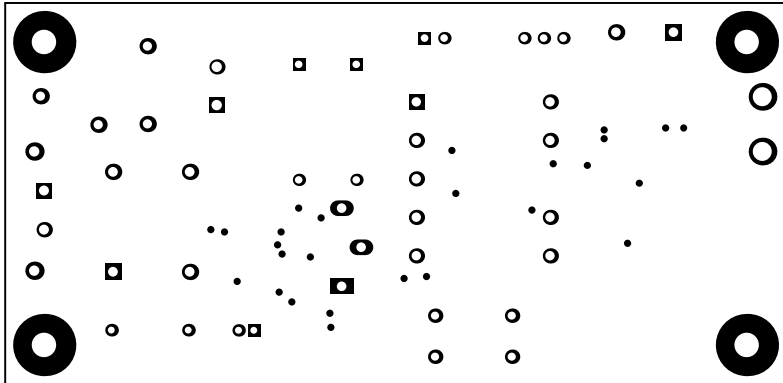
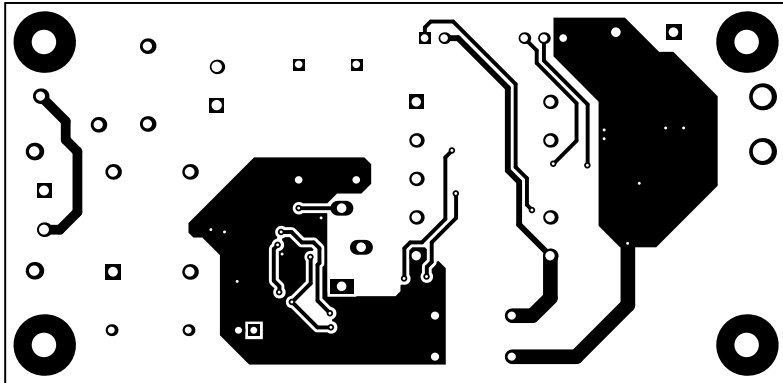


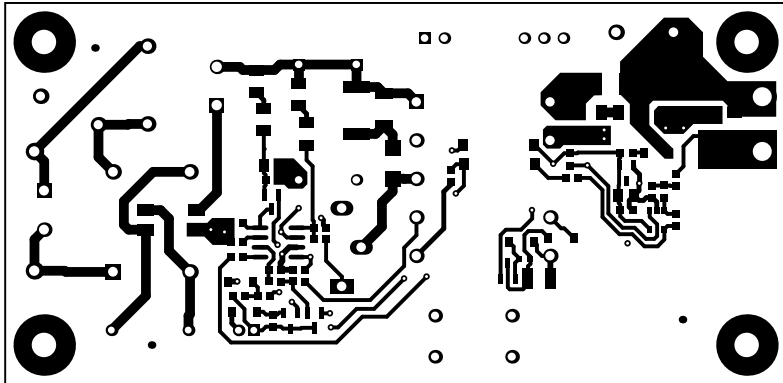
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP6023-1	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay			
PLOT NAME = Top Overlay	GENERATED : 8/14/2014 1:01:53 PM	TEXAS INSTRUMENTS	



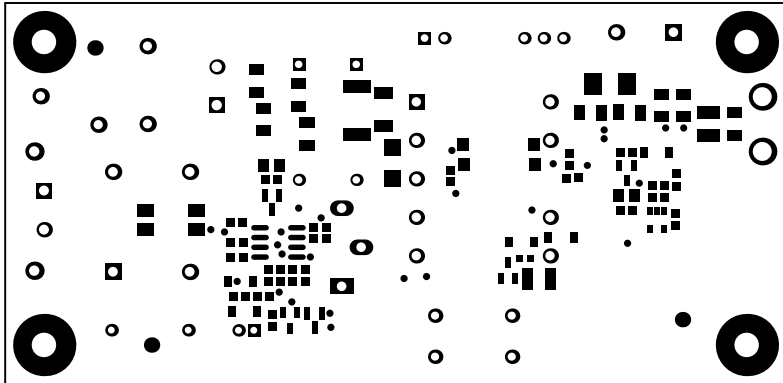
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP6023-1	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Solder			
PLOT NAME = Top Solder Mask	GENERATED : 8/14/2014 1:01:55 PM	TEXAS INSTRUMENTS	



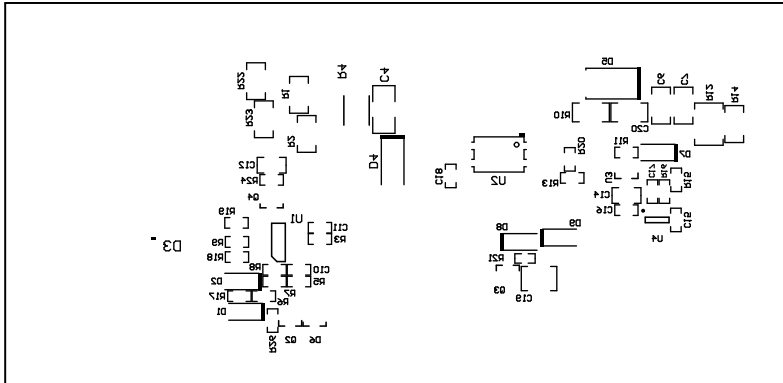
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP6023-1	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Layer			
PLOT NAME = Top Layer	GENERATED : 8/14/2014 1:01:56 PM	TEXAS INSTRUMENTS	



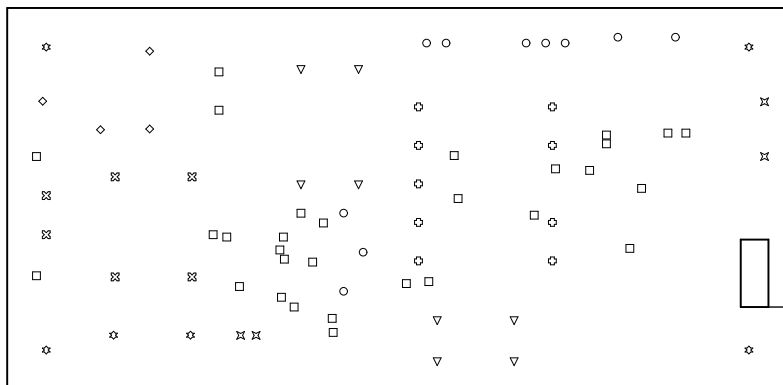
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP6023-1	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer			
PLOT NAME = Bottom Layer	GENERATED : 8/14/2014 1:01:57 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP6023-1	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder			
PLOT NAME = Bottom Solder Mask	GENERATED : 8/14/2014 1:01:58 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP6023-1	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay			
PLOT NAME = Bottom Overlay	GENERATED : 8/14/2014 1:02:00 PM	TEXAS INSTRUMENTS	

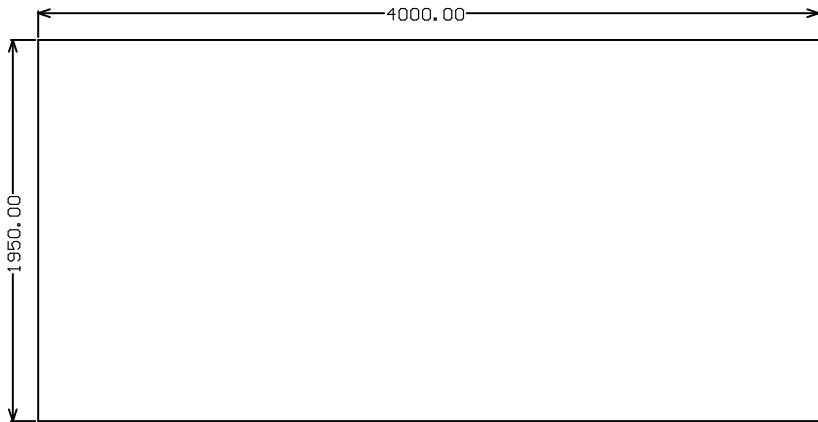


Symbol	Hit Count	Tool Size	Plated	Hole Type
□	26	16mil (0.406mm)	PTH	Round
◇	2	35.433mil (0.9mm)	PTH	Round
⊗	2	37mil (0.94mm)	PTH	Round
▽	4	39.37mil (1mm)	PTH	Round
○	5	40mil (1.016mm)	PTH	Round
▽	4	43mil (1.092mm)	PTH	Round
◇	4	48mil (1.219mm)	PTH	Round
⊗	9	49mil (1.245mm)	PTH	Round
○	5	50mil (1.27mm)	PTH	Round
⊗	6	51.181mil (1.3mm)	PTH	Round
□	4	54mil (1.372mm)	PTH	Round
⊗	2	98.425mil (2.5mm)	PTH	Round
⊗	4	125.984mil (3.2mm)	PTH	Round
77 Total				

Drill Table

PLACE MFGRS LOGO, UL FLAMMABILITY RATING, T_g TEMP, UL FILE NO AND DATE CODE HERE IN BOTTOM SILKSCREEN

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP6023-1	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing			
PLOT NAME = Drill Drawing	GENERATED : 8/14/2014 1:02:01 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP6023-1	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions			
PLOT NAME = Board Dimensions	GENERATED : 8/14/2014 1:02:03 PM	TEXAS INSTRUMENTS	

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